



**SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER**

Reverse Voltage - 50 to 1000 V

Forward Current - 1 A

**FEATURES**

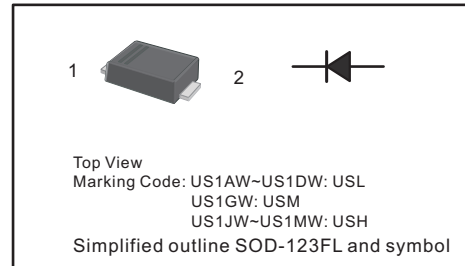
- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- High efficiency
- Lead free in comply with EU RoHS 2011/65/EU directives

**MECHANICAL DATA**

- Case: SOD-123FL
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 15mg/0.00053oz

**PINNING**

PIN	DESCRIPTION
1	Cathode
2	Anode



**Maximum Ratings and Electrical characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	US1AW	US1BW	US1DW	US1GW	US1JW	US1KW	US1MW	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $T_c = 125\text{ }^\circ\text{C}$	$I_{F(AV)}$	1							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	$I_{FSM}$	30							A
Maximum Instantaneous Forward Voltage at 1 A	$V_F$	1.0		1.3		1.65			V
Maximum DC Reverse Current at Rated DC Blocking Voltage $T_a = 25\text{ }^\circ\text{C}$ $T_a = 125\text{ }^\circ\text{C}$	$I_R$	5 100							$\mu\text{A}$
Maximum Reverse Recovery Time <sup>(1)</sup>	$t_{rr}$	50				75			ns
Typical Junction Capacitance <sup>(2)</sup>	$C_j$	15							pF
Typical Thermal Resistance <sup>(3)</sup>	$R_{\theta JA}$	85							$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150							$^\circ\text{C}$

(1) Measured with  $I_F = 0.5\text{ A}$ ,  $I_R = 1\text{ A}$ ,  $I_{rr} = 0.25\text{ A}$ .

(2) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(3) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



Fig.1 Forward Current Derating Curve

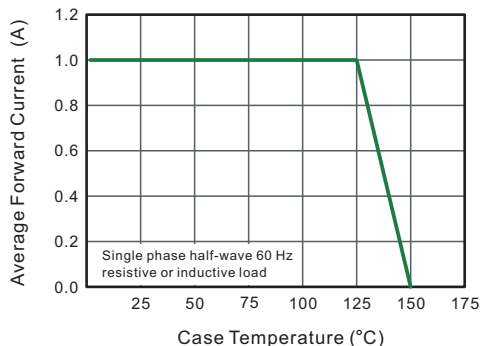


Fig.2 Typical Reverse Characteristics

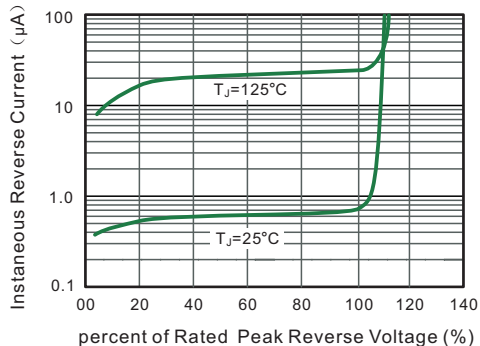


Fig.3 Typical Forward Characteristics

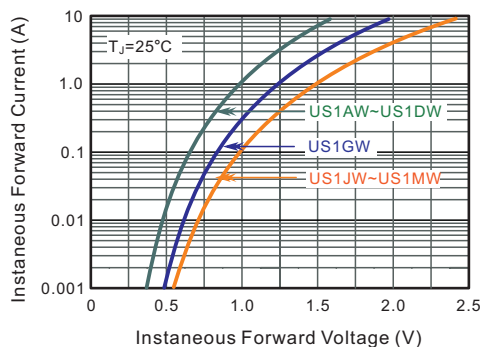


Fig.4 Maximum Non-Repetitive Peak Forward Surge Current

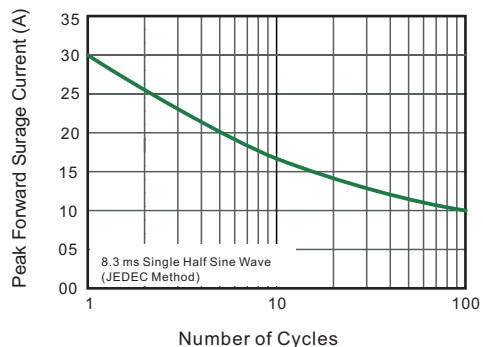


Fig.5- Typical Transient Thermal Impedance

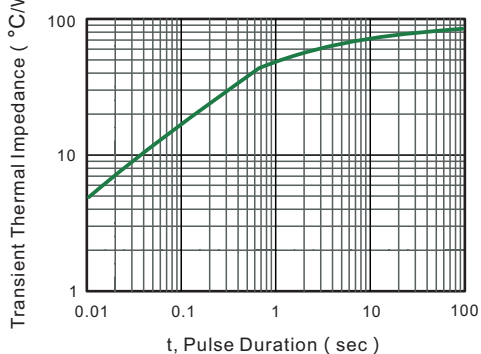
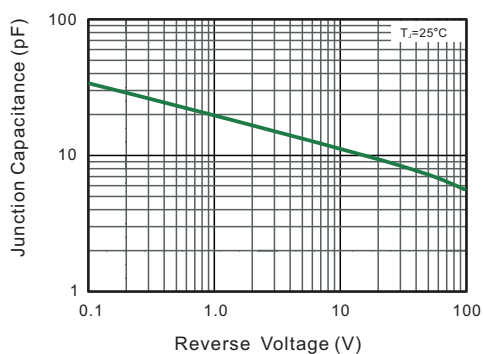


Fig.6 Typical Junction Capacitance

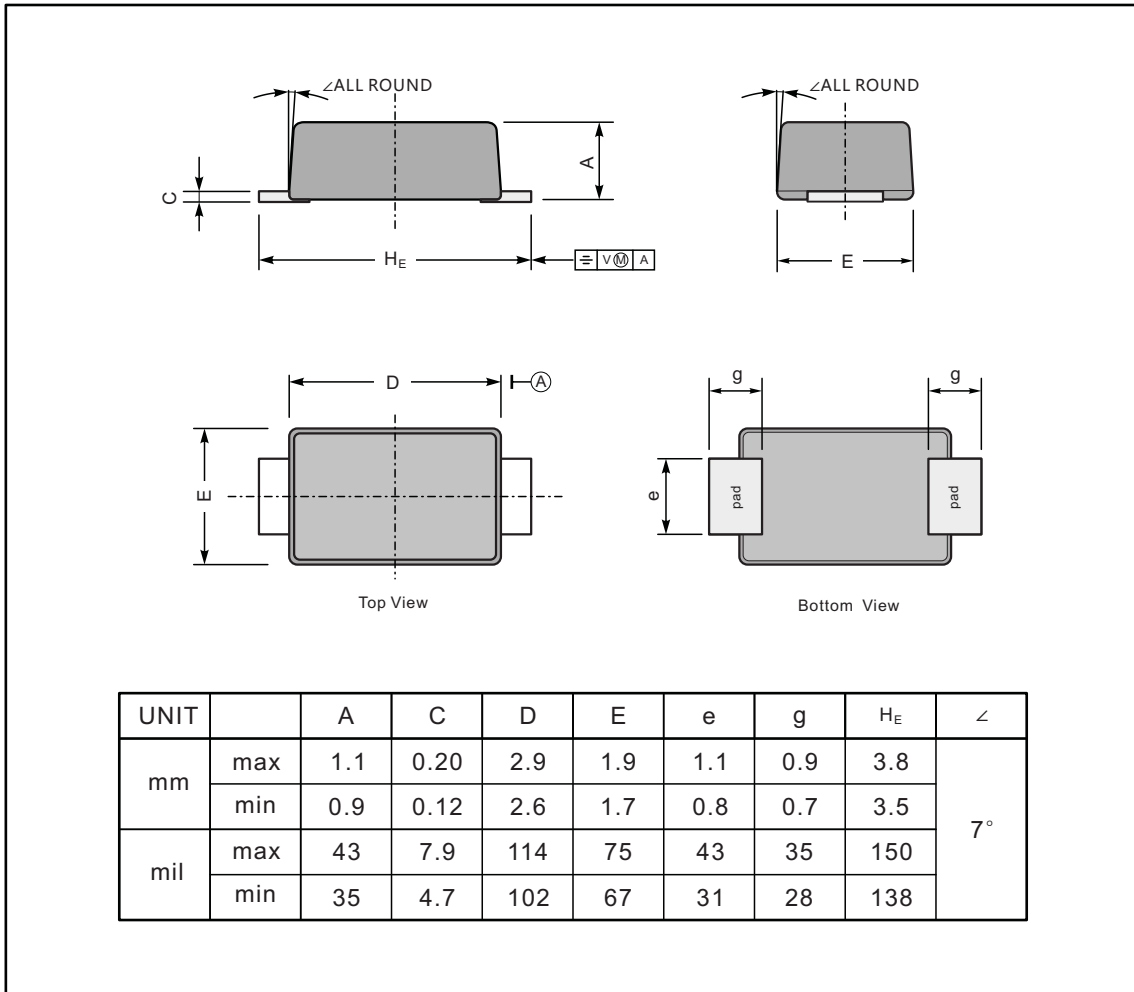




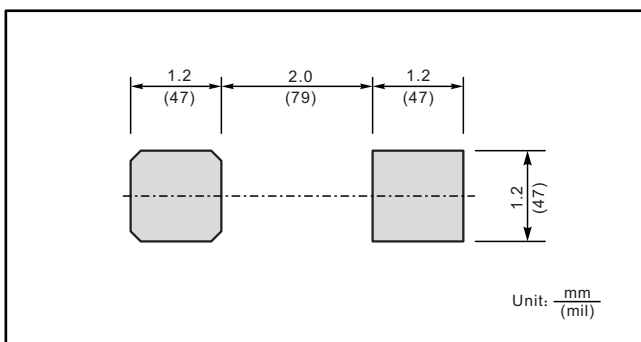
**PACKAGE OUTLINE**

Plastic surface mounted package; 2 leads

SOD-123FL



**The recommended mounting pad size**



**Marking**

Type number	Marking code
US1AW	USL
US1BW	
US1DW	
US1GW	USM
US1JW	USH
US1KW	
US1MW	

单击下面可查看定价，库存，交付和生命周期等信息

[>>JINGDAO\(晶导\)](#)